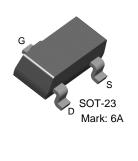


SEMICONDUCTOR®

MMBT4416

N-Channel RF Amplifiers • This device is designed for RF amplifiers.

- Sourced from process 50.

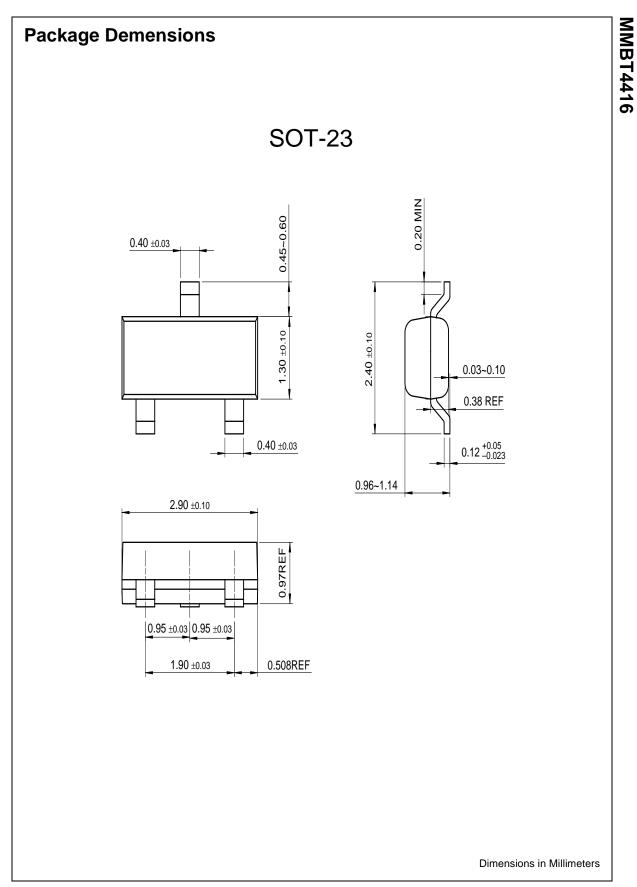


Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{DG}	Drain-Gate Voltage	30	V
V _{GS}	Gate-Source Voltage	30	V
I _G	Gate Current	10	mA
P _D	Total Device Dissipation @T _A =25°C	225	mW
-	Derate above 25°C	1.8	mW/°C
R _{θJA}	Thermal Resistance Junction to Ambient	556	°C/W
T _J , T _{STG}	Junction and Storage Temperature Range	- 55 ~ 150	°C

Electrical Characteristics TA=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Chara	cteristics					
V _{(BR)GSS}	Gate-Source Breakdown Voltage	$V_{DS} = 0$, $I_G = 1\mu A$	30			V
I _{GSS}	Gate Reverse Current	$V_{GS} = 20V, V_{DS} = 0$			1	nA
		$V_{GS} = 20V, V_{DS} = 0, T_A = 150^{\circ}C$			200	nA
V _{GS} (off)	Gate Source Cut-off Voltage	$V_{DS} = 15V, I_{D} = 1nA$	2.5		6	V
V _{GS}	Gate Source Voltage	$V_{DS} = 15V, I_{D} = 0.5mA$	-1		-5.5	V
On Chara	cteristics					
I _{DSS}	Zero-Gate Voltage Drain Current	$V_{GS} = 15V, V_{GS} = 0$	5		15	μΑ
V _{GS} (f)	Gate-Source Forward Voltage	$V_{DS} = 0$, $I_G = 1mA$			1	V
Small Sig	nal Characteristics					
IY _{fs} I	Forward Transfer Admittance	V _{DS} = 15V, V _{GS} = 0, f = 1KHz	4500		7500	μmhos
ly _{os} l	Output Admittance	V _{DS} = 15V, V _{GS} = 0, f = 1KHz			50	μmhos
C _{iss}	Input Capacitance	V _{DS} = 15V, V _{GS} = 0, f = 1MHz			4	РF
Crss	Reverse Transfer Capacitance	V _{DS} = 15V, V _{GS} = 0, f = 1MHz			0.9	РF
C _{oss}	Output Capacitance	V _{DS} = 15V, V _{GS} = 0, f = 1MHz			2	РF
Functiona	I Characteristics					
NF	Noise Figure	$V_{DS} = 15V, I_D = 5mA, R_g = 100\Omega,$			2	dB
		f = 100MHz			4	
G _{ps}	Common Source Power Gain	$V_{DS} = 15V, I_{D} = 5mA, R_{g} = 100\Omega,$	18			dB
		f = 100MHz	10			



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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.